TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC592AP,TC74HC592AF

8 Bit Binary Counter with Input Register

The TC74HC592A is high speed CMOS 8-BIT REGISTER COUNTER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The internal counter counts at positive edge of Counter Clock (CCK) when Counter Clock Enable ($\overline{\text{CCKEN}}$) is held "L" level. If Counter clear ($\overline{\text{CCLR}}$) is held "L", the internal counter is cleared asynchronously to clock.

Input A to H are loaded to register at positive edge of Register Clock (RCK), and the register outputs are loaded to Counter when Counter Load $(\overline{\text{CLOAD}})$ is held "L" level.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

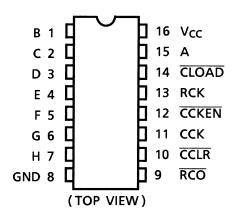
- High speed: $f_{max} = 35 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 10 LSTTL loads for QA to QH
- Symmetrical output impedance: | I_{OH} | = I_{OL} = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS592

DIP16-P-300-2.54A TC74HC592AF SOP16-P-300-1.27A

Weight

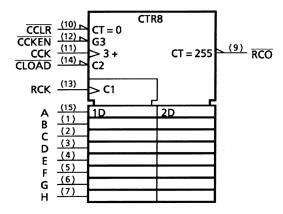
DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

Pin Assignment

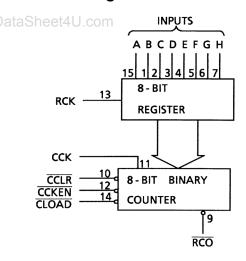


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IEC Logic Symbol



Block Diagram



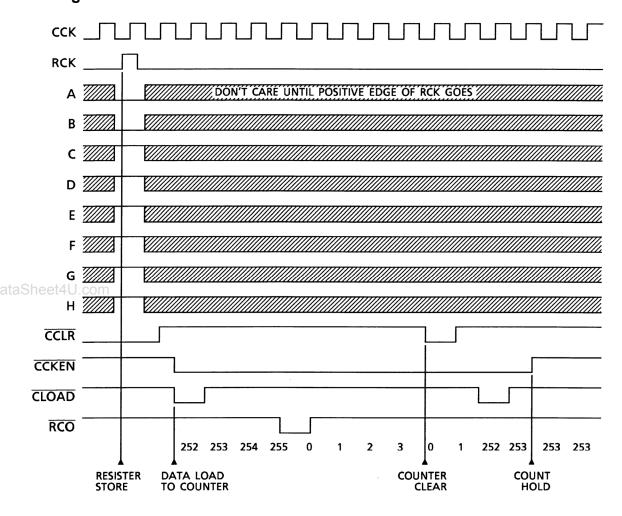
Truth Table

		Inputs	_		Function
RCK	CLOAD	CCLR	CCKEN	CCK	Tunction
Х	L	Н	Х	Х	Register Data is Loaded into Counter
Х	Н	L	Х	Х	Counter Clear
	Н	Н	Х	Х	The Data of a Thru H Inputs is Stored into Register
\Box	Н	Н	Х	Х	Register State is not Changed
Х	Н	Н	L	\Box	Counter Advances the Count
Х	Н	Н	L	\neg	No Count
Х	Н	Н	Н	Х	No Count

X: Don't care

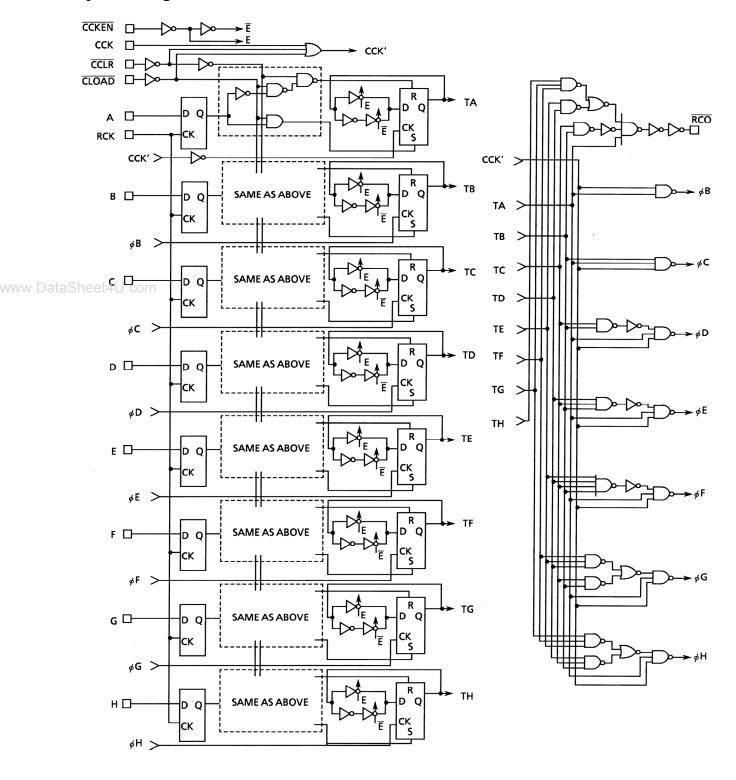
 $\overline{RCO} = \overline{QA' \cdot QB' \cdot QC' \cdot QD' \cdot QE' \cdot QF' \cdot QG' \cdot QH'}$ (QA' to QH': internal outputs of the counter)

Timing Chart



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System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	−0.5 to V _{CC} + 0.5	٧
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

www.DataSheet4U.coUsing continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	−40 to 85	ç
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

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Electrical Characteristics

DC Characteristics

Characteristics	Symbol		Test Condition VCC (V)		-	Γa = 25°(Ta = -40 to 85°C		Unit
Characteristics	Symbol				Min	Тур.	Max	Min	Max	Offic
				2.0	1.50	_	_	1.50	_	
High-level input voltage	V_{IH}	_		4.5	3.15	_	_	3.15	_	V
					4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V_{IL}	_		4.5	_	_	1.35	_	1.35	V
l				6.0	_	_	1.80	_	1.80	
	V _{ОН}	V _{IN} = V _{IH} or V _{IL}	Ι _{ΟΗ} = -20 μΑ	2.0	1.9	2.0	_	1.9	_	
				4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
eet4U.com			I _{OH} = -4 mA	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
		V _{IN} = V _{IH} or		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V_{OL}			6.0	_	0.0	0.1	_	0.1	V
		V _{IL}	I _{OL} = 4 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 5.2 mA	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I _{IN}	$V_{IN} = V_{C}$	V _{IN} = V _{CC} or GND		_	_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_C$	_C or GND	6.0	_	_	4.0	_	40.0	μА

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Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Test Condition			Ta = -40 to 85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width	hw an		2.0	_	75	95	
(CCK, RCK)	t _{W (H)}	_	4.5	_	15	19	ns
(OOK, NOK)	t _{W (L)}		6.0	_	13	16	
Minimum pulse width			2.0	_	100	125	
(CCLR)	t _{W (L)}	_	4.5	_	20	25	ns
(OOLIK)			6.0	_	16	21	
Minimum pulse width			2.0	_	175	220	
(CLOAD)	t _{W (L)}	_	4.5	_	35	44	ns
(OLOAD)			6.0	_	30	37	
Minimum set-up time			2.0	_	75	95	
(CCKEN-CCK)	t _s	_	4.5	_	15	19	ns
(COULD COOK)			6.0	_	13	16	
Minimum set-up time			2.0	_	150	190	
(RCK-CLOAD)	t _S	_	4.5	_	30	38	ns
(NON-OLOAD)			6.0	_	26	32	
Minimum set-up time			2.0	_	100	125	
(A to H-RCK)	t _s	_	4.5	_	20	25	ns
(A to Ti-Rory			6.0	_	17	21	
			2.0	_	5	5	
Minimum hold time	t _h	_	4.5	_	5	5	ns
			6.0	_	5	5	
Minimum removal time			2.0	_	75	95	
(CCLR)	t _{rem}	_	4.5	_	15	19	ns
(OOLIX)			6.0		13	16	
Minimum removal time			2.0	_	75	95	
(CLOAD)	t _{rem}	_	4.5	_	15	19	ns
(OLOAD)			6.0	_	13	16	
			2.0	_	4	3.5	
Clock frequency	f	_	4.5	_	22	18	MHz
			6.0	_	26	21	



AC Characteristics ($C_L = 15 \text{ pF}$, $V_{CC} = 5 \text{ V}$, $Ta = 25^{\circ}\text{C}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition		Тур.	Max	Unit
Output transition time	t _{TLH}	_	_	6	12	ns
Propagation delay time (CCK- RCO)	t _{pLH}	_	_	25	38	ns
Propagation delay time (RCK- RCO)	t _{pLH}	_	_	39	60	ns
Propagation delay time (CCLR - RCO)	t _{pLH}	_	_	24	36	ns
Propagation delay time (CLOAD - RCO)	t _{pLH}	_	_	35	53	ns
Maximum clock frequency	f _{max}	_	25	35	_	MHz

www.DataSheAC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta –40 to	- Unit	
Onaracteristics	Cymbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	O'iiit
	4		2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8	15	_	19	ns
	t _{THL}		6.0	_	7	13	_	16	
Propagation delay	4		2.0	_	94	220	_	275	
time	t _{pLH}	_	4.5	_	29	44	_	55	ns
(CCK-RCO)	t _{pHL}		6.0	_	24	37	_	47	
Propagation delay			2.0	_	160	340	_	425	
time	t _{pLH}	_	4.5	_	45	68	_	85	ns
(RCK-RCO)	t _{pHL}		6.0	_	34	58	_	73	
Propagation delay			2.0	_	89	215	_	270	
time	t_{pLH}	_	4.5	_	28	43	_	54	ns
(CCLR - RCO)			6.0	_	22	37	_	46	
Propagation delay	1		2.0	_	140	300	_	375	
time	t _{pLH}	_	4.5	_	40	60	_	75	ns
(CLOAD - RCO)	t _{pHL}		6.0	_	30	51	_	64	
			2.0	4	20	_	3.5	_	
Maximum clock frequency	f _{max}	_	4.5	22	33	_	18	_	MHz
			6.0	26	49	_	21	_	
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Power dissipation capacitance	C _{PD} (Note)	_		_	31	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$



Package Dimensions

DIP16-P-300-2.54A

Unit: mm

19.75MAX

19.25±0.2

0.95±0.1

1.4±0.1

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^{0.5±0.1} ⊕ 0.25 ₪

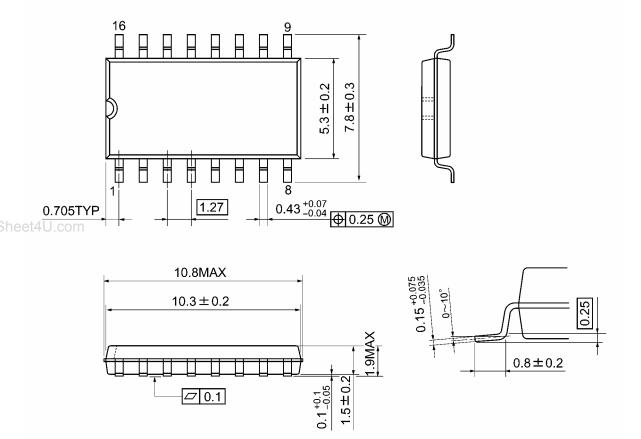
Weight: 1.00 g (typ.)

0.735TYP

2.54

Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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20070701-EN GENERAL

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